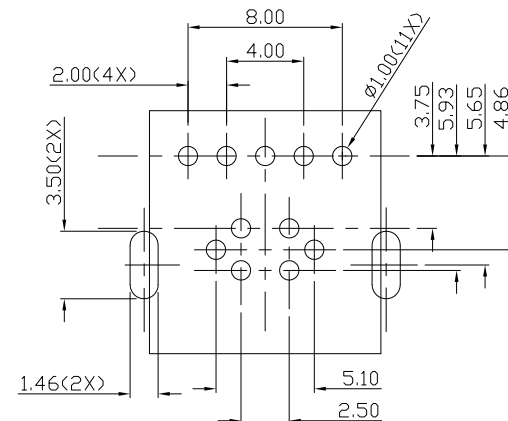
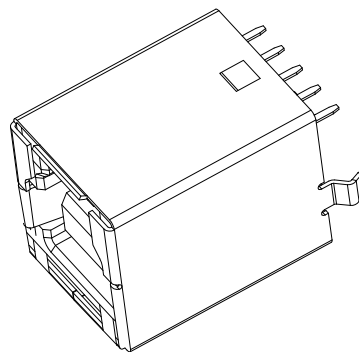
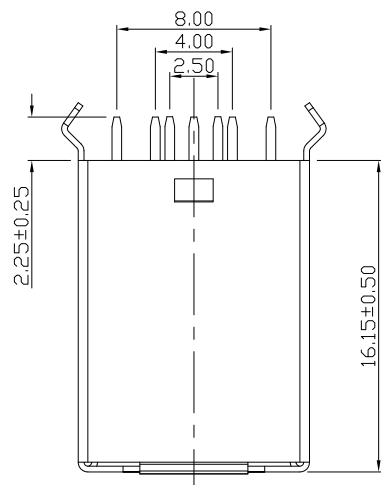




PCB LAYOUT

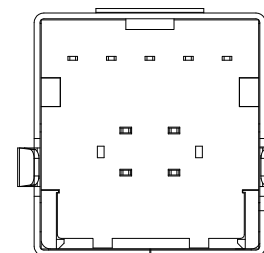
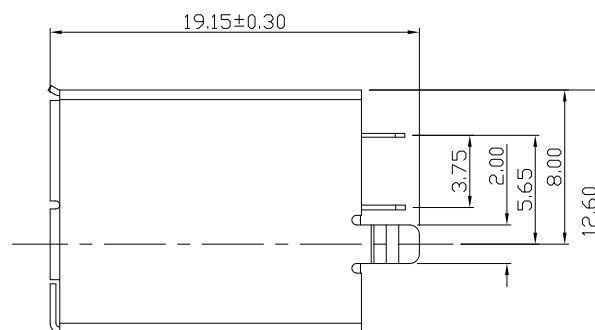
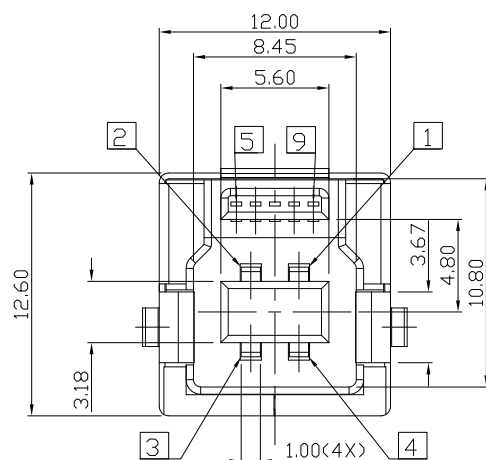


TABLE:

XX	PLATING
11	G.F./TIN PLATED前金後錫
12	3U"G./TIN PLATED前金後錫
13	5U"G./TIN PLATED前金後錫
14	10U"G./TIN PLATED前金後錫
15	15U"G./TIN PLATED前金後錫
16	20U"G./TIN PLATED前金後錫
17	30U"G./TIN PLATED前金後錫
18	50U"G./TIN PLATED前金後錫

6	USB3.0-B母座立式-外殼	CD000992002-7	1	BRASS T=0.30mm FINISH:NICKEL	
5	USB3.0-B母座立式-后塞	CD000992002-6	1	High temp. thermoplastic UL 94V-0	
4	USB3.0-B母座立式-下座	CD000992002-5	1	High temp. thermoplastic UL 94V-0	
3	USB3.0-B母座立式-上座	CD000992002-4	1	High temp. thermoplastic UL 94V-0	
2	USB3.0-B母座立式-端子	CD000992002-2XX	4	PHOSPHOR BRONZE T=0.25mm SEE TABLE	
1	USB3.0-B母座立式-PIN 5	CD000992002-1XX	1	BRASS T=0.20mm SEE TABLE	
項次	品名	料號	數量	規格	備注

ELECTRICAL CHARACTERISTICS:
30V DC/AC 1A Max.
CONTACT RESISTANCE:30mΩ Max.
INSULATION RESISTANCE:
100MΩ Min.at 500V DC.
DIELECTRIC STRENGTH:
750V AC/1 minute.
INSERTION FORCE:3.6kgf MAX
WITHDRAWAL:1.0kgf MIN



東莞世華電子有限公司

SHYH HWA ELECTRONICS CO.,LTD.(DONGGUAN)

地址:東莞市塘廈鎮諸佛嶺178工業區

TEL:0769-7910020-1 FAX:0769-7910210

DRAWN BY 張黎林

CHECKED BY

APPROVED BY

ITEM

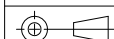
USB3.0-B母座立式

PART NO

CD000992002-XX

TOLERANCE

ANGLE PROJECTION



.X±0.3
.XX±0.15

UNIT

mm

SCALE

1:1

DATE

10/29/2010

REVISION



修訂圖面

DESCRIPTION

DATE

10/29/2010